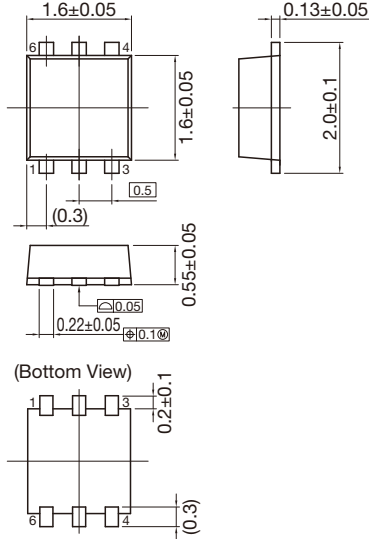
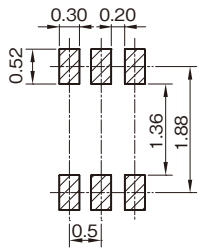
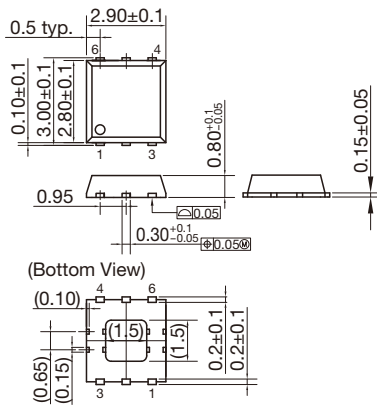
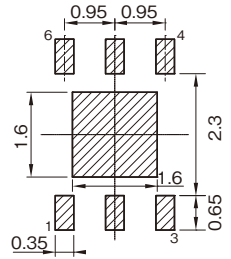


封装

封装名	外形尺寸图	推荐焊盘尺寸图
SON-6C	 SON-6C package dimensions (mm): - Top View: 1.6±0.05 (width), 1.6±0.05 (height), 0.13±0.05 (lead width), 2.0±0.1 (total width), 0.5 (pitch), (0.3) (lead length), 0.55±0.05 (lead height), 0.22±0.05 (lead thickness), (0.10) (lead width). - Bottom View: 0.2±0.1 (pitch), (0.3) (lead length).	 SON-6C recommended pad dimensions (mm): - Pad width: 0.30, 0.20 - Pad pitch: 0.52 - Pad length: 1.36, 1.88 - Pad thickness: 0.5
SON-6D	 SON-6D package dimensions (mm): - Top View: 0.5 typ. (lead length), 2.90±0.1 (width), 0.10±0.1 (lead width), 3.00±0.1 (total width), 2.80±0.1 (total height), 0.80±0.05 (lead height), 0.15±0.05 (lead thickness), 0.95 (pitch), 0.30±0.05 (lead length), (0.05) (lead width). - Bottom View: (0.10) (pitch), (0.15) (lead length), (0.65) (lead width), 1.5 (pitch), 0.2±0.1 (pitch), 0.2±0.1 (pitch).	 SON-6D recommended pad dimensions (mm): - Pad width: 0.95, 0.95 - Pad pitch: 1.6 - Pad length: 2.3 - Pad thickness: 0.65 - Pad width: 0.35